

## N-Channel 80-V (D-S) MOSFET

#### Description

The device is using trench DMOS technology. This advanced technology has been especially tailored to minimize  $R_{DS(ON)}$ , provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

The device meets the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

#### **Features**

- $R_{DS(ON)} = 7m\Omega @ V_{GS} = 10V$
- Super Low Gate Charge
- Excellent dv/dt Capability
- 100% EAS Guaranteed
- Green Device Available

#### **Typical Applications**

- Networking
- Load Switch
- Synchronous Rectifier
- Quick Charger

Package type: PDFN 3.3X3.3

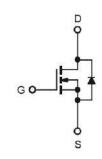
#### Packing & Order Information

3,000/Reel

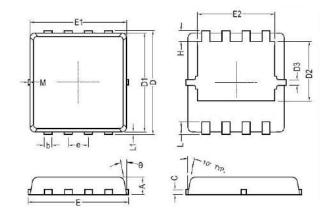


RoHS Compliant

#### **Graphic Symbol**

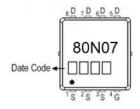


#### **Package Dimension**



REF.	Millimeter		REF.	Millimeter				
	Min.	Nom.	Max.	KEF.	Min.	Nom.	Max.	
Α	0.70	0.75	0.80	E1	3.00	3.15	3.20	
b	0.25	0.30	0.35	E2	2.39	2.59		
С	0.10	0.15	0.25	е	0.65 BSC			
D	3.25	3.35	3.45	Н	0.30	0.39	0.50	
D1	3.00	3.10	3.20	L	0.30 0.40		0.50	
D2	1.78	1.88	1.98	L1	- 0.13		0.20	
D3	-	0.13	-	$\theta$	- 10°		12°	
Е	3.20	3.30	3.40	М	-	-	0.15	

#### Marking





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#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings					
Symbol	Parameter	Value	Units		
V <sub>DS</sub>	Drain-Source Voltage	80	V		
Vgs	Gate-Source Voltage	±20	V		
I <sub>D</sub>	Continuous Drain Current¹ (Tc =25°C)	60	Α		
	Continuous Drain Current¹ (T <sub>C</sub> =100°C)	38	A		
I <sub>DM</sub>	Pulsed Drain Current <sup>1,2</sup>	240	Α		
I <sub>AS</sub>	Single Pulse Avalanche Current, L =0.1mH <sup>3</sup>	50	Α		
E <sub>AS</sub>	Single Pulse Avalanche Energy, L =0.1mH³	125	mJ		
P <sub>D</sub>	Power Dissipation <sup>4</sup> (T <sub>C</sub> =25°C)	60	W		
T <sub>J</sub> /T <sub>STG</sub>	Operating Junction and Storage Temperature	-55 to 150	°C		

Thermal Resistance Ratings						
Symbol	Parameter	Maximum	Units			
$R_{\theta JA}$	Maximum Junction-to-Ambient <sup>1</sup>	62	°C/W			
Rejc	Maximum Junction-to-Case <sup>1</sup>	2.05	°C/W			

Electrical Characteristics (T <sub>J</sub> =25°C unless otherwise specified)						
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V <sub>GS (th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.2	1.6	2.5	V
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	80	-	-	V
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C V <sub>DS</sub> =64V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C	-	-	1 10	μA
R <sub>DS</sub> (on)	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =8A V <sub>GS</sub> =4.5V, I <sub>D</sub> =6A	-	5.8 8.6	7 11	mΩ
gfs	Forward Transconductance	V <sub>DS</sub> =10V, I <sub>D</sub> =3A	-	9	-	S
EAS	Single Pulse Avalanche Energy <sup>5</sup>	V <sub>DD</sub> =25V, L =0.1mH, I <sub>AS</sub> =30A	45	-	-	mJ
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	I <sub>S</sub> =1A, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	-	-	1.0	V
Is	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current	-	-	60	
Ism	Pulsed Source Current <sup>2,6</sup>		-	-	120	Α

#### **Notes**

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2. The data tested by pulsed, pulse width  $\leq$  300us, duty cycle  $\leq$  2%.
- 3. The EAS data shows maximum rating. The test condition is  $V_{DD}$ =50V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =50A.
- 5. The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



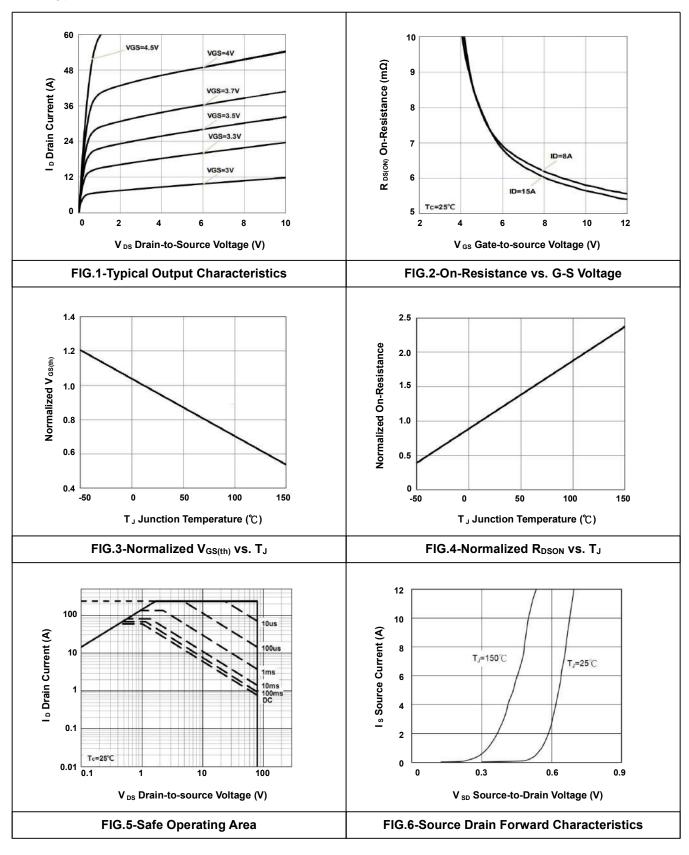
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Dynamic						
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Qg	Total Gate Charge <sup>2</sup>	V <sub>DS</sub> =40V		31		
Qgs	Gate-Source Charge	I <sub>D</sub> =30A		4		nC
Qgd	Gate-Drain Charge	V <sub>GS</sub> =10V		9.5		
t <sub>d(on)</sub>	Turn-On Delay Time <sup>2</sup>	V <sub>DS</sub> =40V		22		
tr	Rise Time	I <sub>D</sub> =30A		16		
td(off)	Turn-Off Delay Time	V <sub>GS</sub> =10V R <sub>G</sub> =6Ω		40		ns
t <sub>f</sub>	Fall Time			31		
C <sub>ISS</sub>	Input Capacitance	V <sub>DS</sub> =40V V <sub>GS</sub> =0V f =1.0MHz		1720		
Coss	Output Capacitance			350		pF
Crss	Reverse Transfer Capacitance			11		
trr	Reverse Recovery Time			40		nS
Qrr	Reverse Recovery Charge	IF=10A, dl/dt=100A/µs, Tj=25°C		55		nC
Rg	Gate Resistance	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f =1.0MHz		1.1		Ω



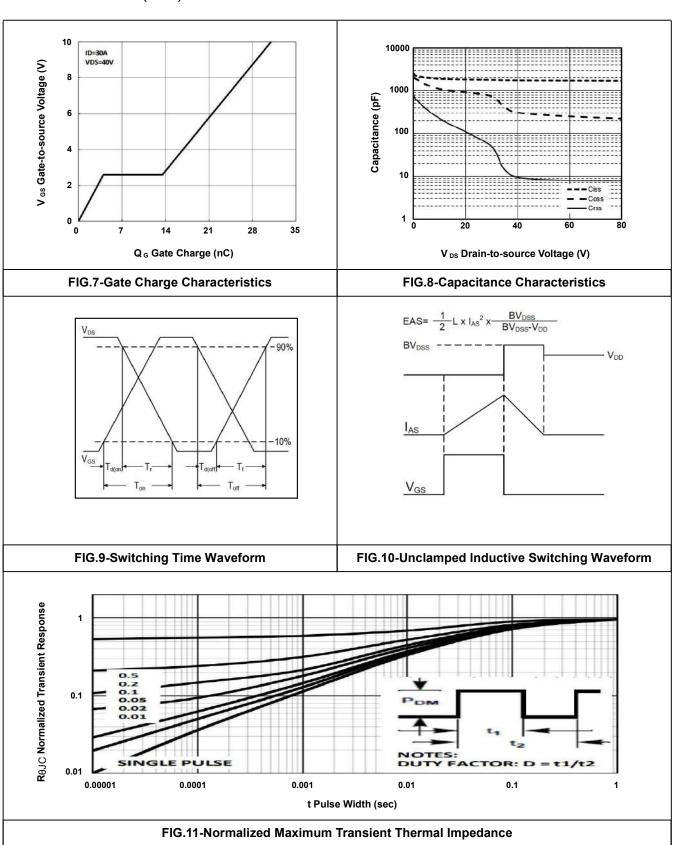
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#### • Typical Electrical Characteristics





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